

## Features

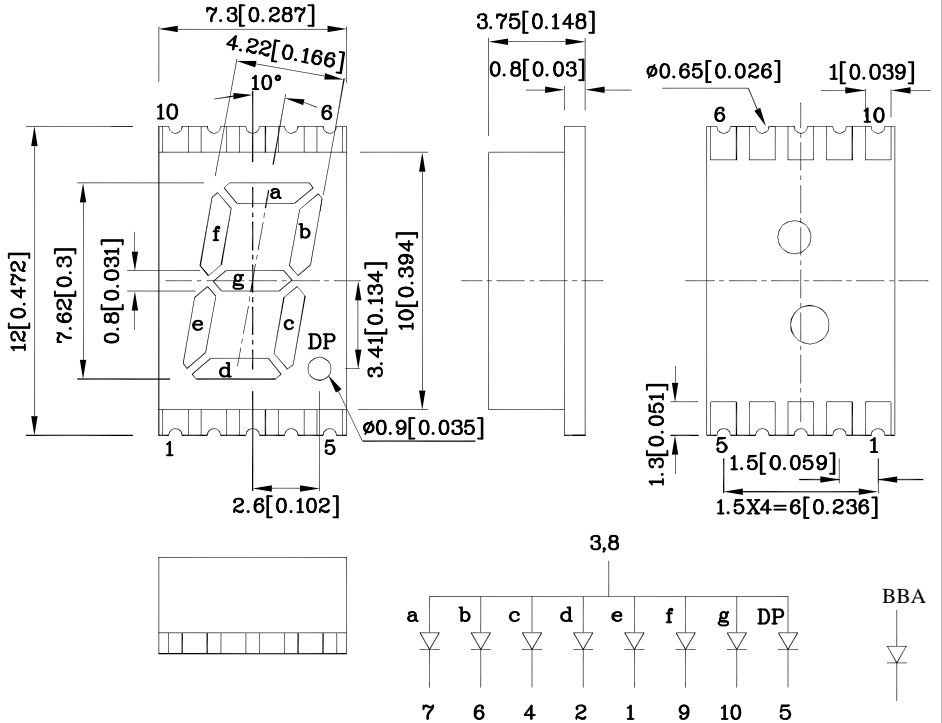
- 0.3 inch digit height
- Robust package
- Low power consumption
- Standard configuration: Gray face w/ white segments
- Standard Package: 550pcs/ Reel
- MSL (Moisture Sensitivity Level): 2a
- RoHS compliant



## ATTENTION

**OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
DISCHARGE  
SENSITIVE  
DEVICES**

## Package Schematics



Notes:

1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25(0.01)$ "unless otherwise noted.
2. Specifications are subject to change without notice.
3. The gap between the reflector and PCB shall not exceed 0.25mm.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		BBA (InGaN)	Unit
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	I <sub>F</sub>	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i <sub>FS</sub>	100	mA
Power Dissipation	P <sub>D</sub>	120	mW
Operating Temperature	T <sub>A</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	
Electrostatic Discharge Threshold (HBM)		1000	V

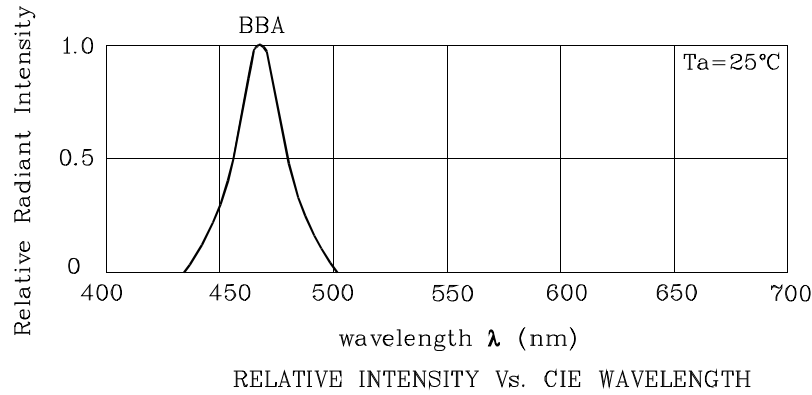
Operating Characteristics (T <sub>A</sub> =25°C)		BBA (InGaN)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =10mA)	V <sub>F</sub>	3.05	V
Forward Voltage (Max.) (I <sub>F</sub> =10mA)	V <sub>F</sub>	4	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	I <sub>R</sub>	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λP	468*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λD	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =10mA)	△λ	21	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	100	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* (If=10mA) ucd		Wavelength CIE127-2007* nm λP	Description
			min.	typ.		
XZFBBA07A	Blue	InGaN	1400*	2490*	468*	Common Anode, Rt. Hand Decimal.

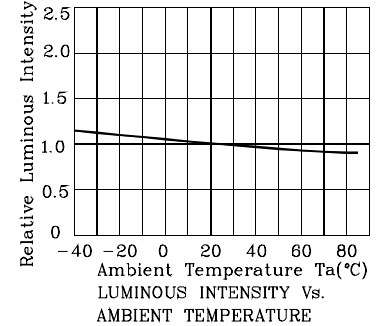
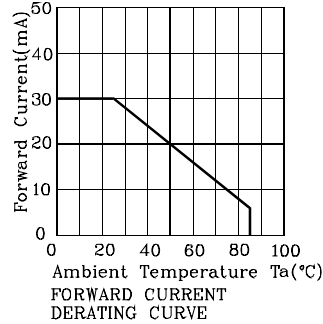
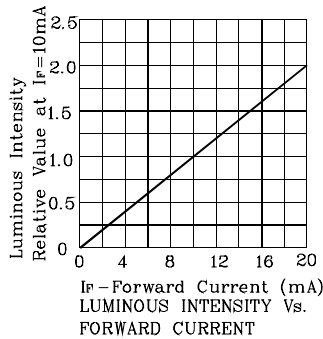
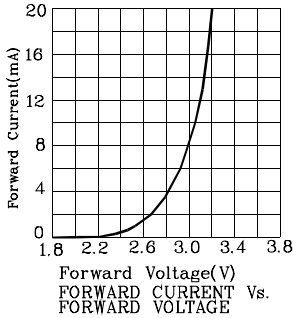
\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Jan 07, 2014

XDSA9165 V7-Z Layout: Maggie L.

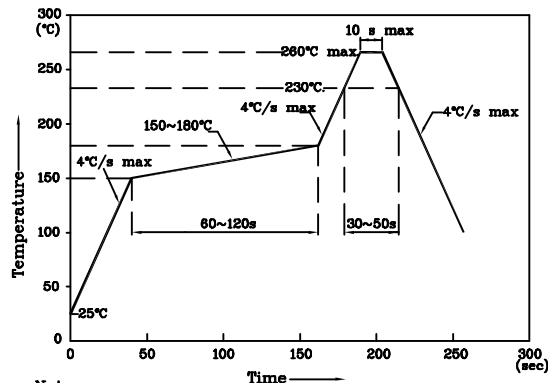


#### ❖ BBA

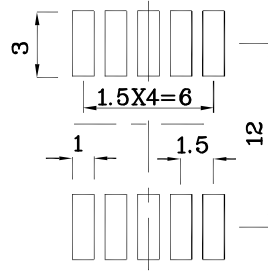


**LED is recommended for reflow soldering and soldering profile is shown below.**

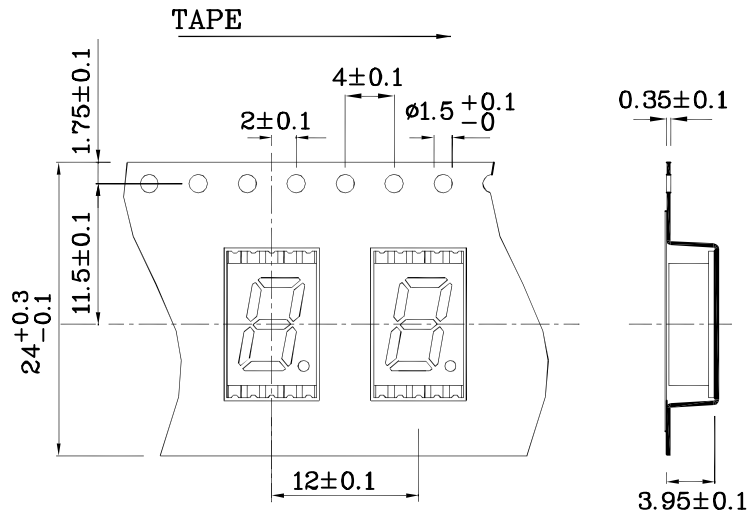
#### Reflow Soldering Profile for SMD Products (Pb-Free Components)



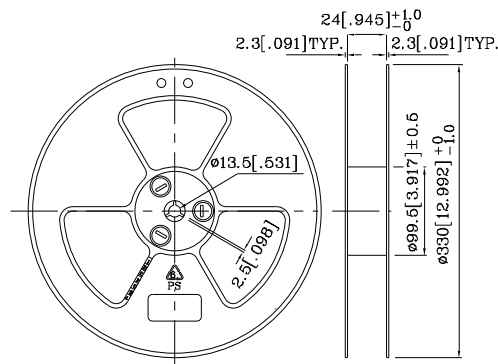
❖ **Recommended Soldering Pattern (Units : mm; Tolerance:  $\pm 0.15$ )**



❖ **Tape Specification (Units : mm)**



❖ **Reel Dimension**



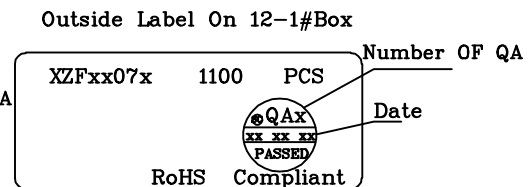
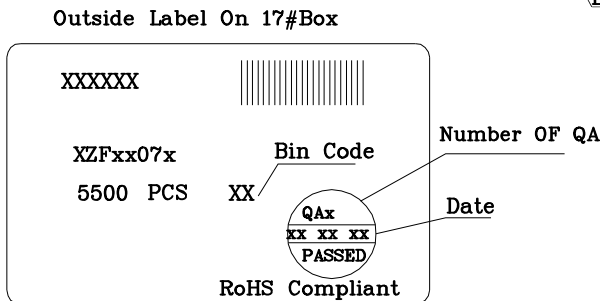
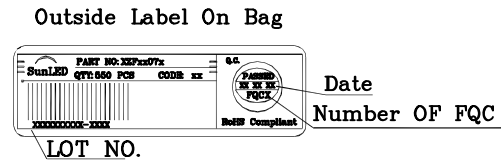
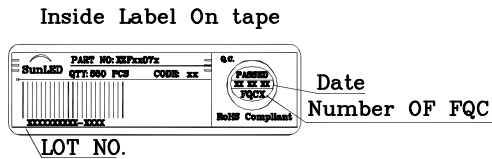
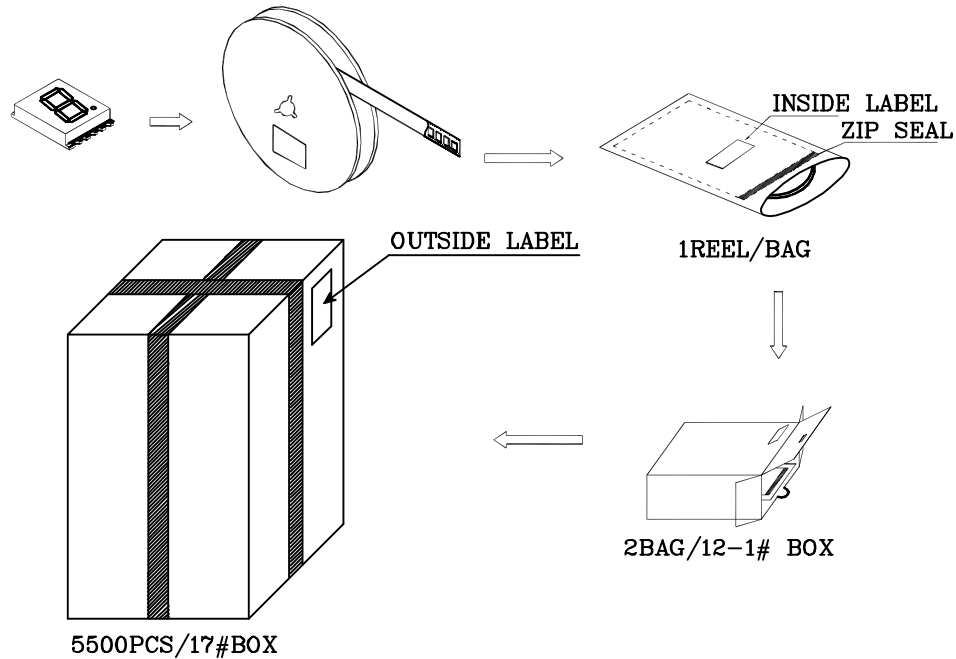
**Remarks:**

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength:  $\pm 1$ nm
2. Luminous intensity / luminous flux:  $\pm 15\%$
3. Forward Voltage:  $\pm 0.1$ V

Note: Accuracy may depend on the sorting parameters.

## PACKING & LABEL SPECIFICATIONS



## TERMS OF USE

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